

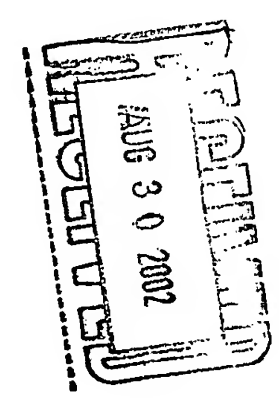


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Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
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Application ID: 10005065  
Title of Invention: ELECTRO-ABSORPTION  
MODULATED LASER WITH HIGH  
OPERATING TEMPERATURE  
TOLERANCE  
First Named Inventor: Stephen Krasulick  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2001-12-04  
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Application Number:  
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Stylesheet Version: 1.0

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Disclosure Statement

## ELECTRO-ABSORPTION MODULATED LASER WITH HIGH OPERATING TEMPERATURE TOLERANCE

First Named Inventor: Mr. Stephen B. Krasulick

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### Attached Files:

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idsids.xml

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